



NOTES:
TP5 and R5 needed for test purpose

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Designed for:	Mod. Date: 8/2/2013
Project Title: 30V...70Vin to 7V@430mA Isolated Flyback	
Sheet Title:	
SVN Rev.: Not in version control	Assembly Variant: Variant name not interpreted Sheet 1 of 1
Drawn By: R. Scibilia	File: PMP8657 Rev. B Schematic.SchDoc Size: B
Engineer: R. Scibilia	Contact: TechSupport



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